# Power MOSFET for 3-Cells Lithium-ion Battery Protection 30 V, 6.5 m $\Omega$ , 19 A, Dual N-Channel, WLCSP6

This N-Channel Power MOSFET is produced using ON Semiconductor's trench technology, which is specifically designed to minimize gate charge and ultra low on resistance.

This device is suitable for applications of Notebook PC.

#### **Features**

- Ultra Low On-Resistance
- Low Gate Charge
- Common–Drain type
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Applications**

• 3-Cells Lithium-ion Battery Charging and Discharging Switch

## **SPECIFICATIONS**

## **ABSOLUTE MAXIMUM RATINGS** at $T_A = 25^{\circ}C(Note 1)$

Parameter	Symbol	Value	Unit
Source to Source Voltage	V <sub>SSS</sub>	30	V
Gate to Source Voltage	V <sub>GSS</sub>	±20	V
Source Current (DC)	I <sub>S</sub>	19	Α
Source Current (Pulse) PW ≤ 10 μs, duty cycle ≤ 1%	I <sub>SP</sub>	76	Α
Total Dissipation (Note 2)	P <sub>T</sub>	2.5	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\theta JA}$	50	°C/W

1. Surface mounted on ceramic substrate(5000  $\text{mm}^2 \times 0.8 \text{ mm}$ ).

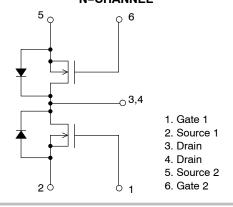


# ON Semiconductor®

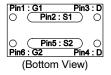
### www.onsemi.com

V <sub>SSS</sub>	R <sub>SS(on)</sub> Max	I <sub>S</sub> Max
	6.5 mΩ @ 10 V	
30 V	8.4 mΩ @ 8 V	19 A
	13 mΩ @ 4.5 V	

# ELECTRICAL CONNECTION N-CHANNEL



#### **PIN ASSIGNMENT**





# MARKING DIAGRAM



#### WLCSP6 CASE 567SZ

A = Assembly Location

= Yeaı

W = Work Week

ZZ = Assembly Lot

= Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 5 of this data sheet.

# **ELECTRICAL CHARACTERISTICS** at $T_A = 25$ °C (Note 1)

			Value			
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Source to Source Breakdown Voltage	V(BR)SSS	I <sub>S</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V
Zero-Gate Voltage Source Current	I <sub>SSS</sub>	V <sub>SS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μΑ
Gate to Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 20 V, V <sub>SS</sub> = 0 V			200	nA
Gate Threshold Voltage	V <sub>GS</sub> (th)	V <sub>SS</sub> = 10 V, I <sub>S</sub> = 1 mA	1.3		2.2	V
Static Source to Source On-State Resistance	R <sub>SS</sub> (on)	V <sub>GS</sub> = 10 V, I <sub>S</sub> = 5 A	3.7	5.0	6.5	mΩ
		V <sub>GS</sub> = 8 V, I <sub>S</sub> = 5 A	4.0	5.3	8.4	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>S</sub> = 5 A	5.5	7.3	13	mΩ
Turn-ON Delay Time	t <sub>d</sub> (on)	V <sub>SS</sub> = 15 V, V <sub>GS</sub> = 10 V		2.7		μs
Rise Time	t <sub>r</sub>	$I_S$ = 5 A, Rg = 5 kΩ Switching Test Circuit		2.0		μs
Turn-OFF Delay Time	t <sub>d</sub> (off)	1		26		μs
Fall Time	t <sub>f</sub>	1		5.7		μs
Total Gate Charge	Qg	V <sub>SS</sub> = 15 V, V <sub>GS</sub> = 4.5 V I <sub>S</sub> = 5 A		18		nC
Forward Source to Source Voltage	$V_{F(S-S)}$	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V, Power Time = 1ms		0.75	1.2	V

<sup>2.</sup> Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

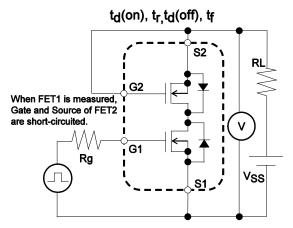


Figure 1. Switching Test Circuit

## **TYPICAL CHARACTERISTICS**

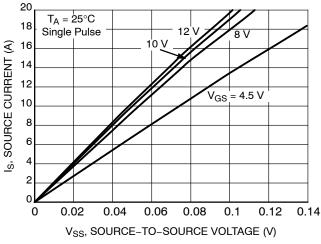


Figure 2. On-Region Characteristics

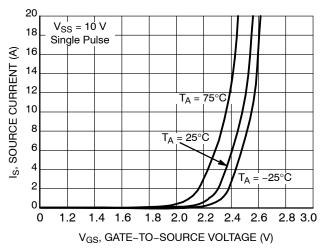


Figure 3. Transfer Characteristics

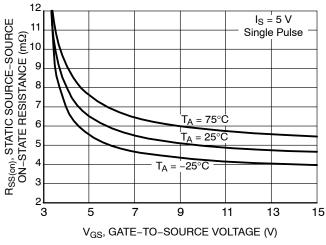


Figure 4. On-Resistance vs. Gate-to-Source Voltage

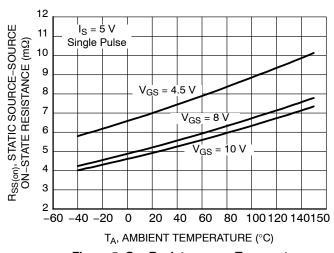


Figure 5. On-Resistance vs. Temperature

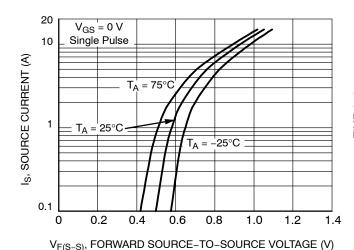


Figure 6. Forward Source-to-Source Voltage vs. Current

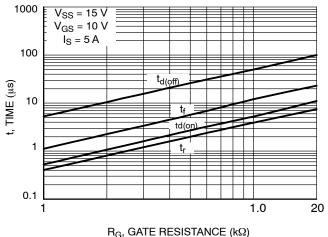


Figure 7. Switching Time vs. Gate Resistance

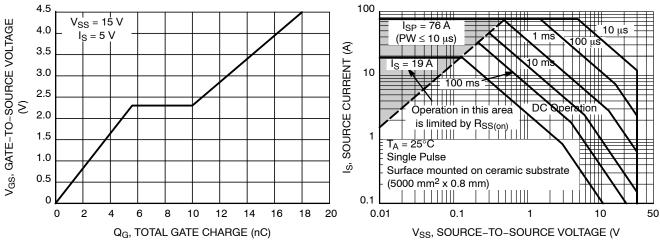


Figure 8. Gate-to-Source Voltage vs. Total Charge

Figure 9. Safe Operating Area

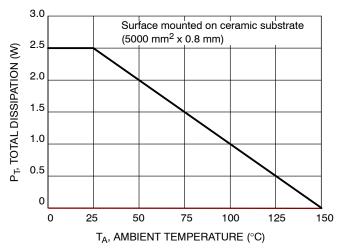


Figure 10. Total Dissipation vs. Temperature

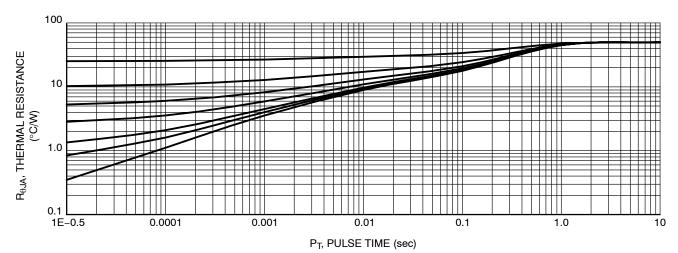


Figure 11. Thermal Response

# **ORDERING INFORMATION**

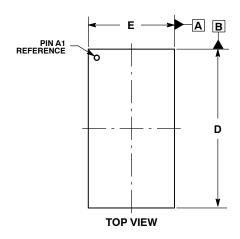
Device	Marking	Package	Shipping (Qty / Packing) <sup>†</sup>
EFC4C012NLTDG	NP	WLCSP6 3.5x1.9x0.21 (Pb-Free / Halogen Free)	5000 / Tape & Reel

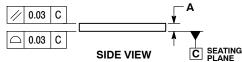
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

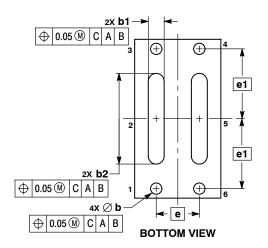


### WLCSP6 3.5x1.9x0.21 CASE 567SZ ISSUE A

**DATE 24 APR 2017** 







#### NOTES:

- DIMENSIONING AND TOLERANCING PER
  ASME V14 5M 1994
- ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.19	0.21	0.23	
b	0.22	0.25	0.28	
b1	0.32	0.35	0.38	
b2	1.97	2.00	2.03	
D	3.47	3.50	3.53	
E	1.87	1.90	1.93	
е	0.95 BSC			
e1	1.54 BSC			

# GENERIC MARKING DIAGRAM\*



A = Assembly Location

′ = Year

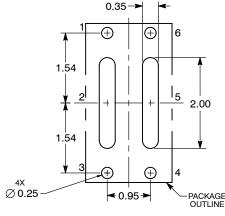
W = Work Week

ZZ = Assembly Lot

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

# RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON16974G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	WLCSP6 3.5x1.9x0.21		PAGE 1 OF 1	

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative